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Device and method for ion beam acceleration and for electron beam pulse formation and amplification

The invention relates to a device and to a method for ion beam acceleration and for electron beam pulse formation and amplification according to the independent claims.

Ion beam acceleration of heavy ions, such as carbon ions, oxygen ions and the like in linear accelerators and cyclotron accelerators requires powers in the region of several megawatts at frequencies of about 300 MHz. Conventional high-frequency power amplifiers, such as cavity amplifiers, which can be used generally in a frequency range of from 50 to 200 MHz and in a power spectrum of up to 50 kW, fail for such high powers and at such frequencies. For higher frequencies and higher powers there is the principle of klystron power amplification, which has gained acceptance in the frequency range of from 350 MHz to 20 GHz. As is the case with travelling-wave tubes, klystron power amplification is a linear arrangement, in which a beam emerging from an electron gun is broken down into electron packages by means of longitudinal velocity modulation. In so-called buncher cavities, that microstructure of the beam is produced by means of directional longitudinal high-frequency electrical fields. The electron beam structured in such a manner then produces the desired high-frequency power in the output cavity or output circuit. Once that high-frequency output has been extracted, its residual energy is finally deposited or discharged into a collector. High-power klystrons having operating frequencies of 200 MHz already have an overall length of 5 m.. For operating frequencies below that, the overall lengths become unmanageable and the apparatuses unwieldy, and the space that they require is associated with considerable costs. A main reason for the enormous amount of space required resides in the formation of the electron beam pulses or of the electron packages in the tube, necessitating very long drift distances of several hundred centimetres. For substantially lower frequencies, such as below 200 MHz, use is therefore made of cavity amplifiers in the form of output tubes.

For the frequency range of from 200 to 350 MHz, however, there are, to date, no economical solutions that permit a high power level of several megawatts and a corresponding operating frequency.

In recent years, a concept known as the klystrode principle has gained acceptance. That principle involves a combination of elements of the tube-operated amplifier and the klystron. The electron pulses are produced by means of a control grid and the pulsed electron beam then passes through an output cavity and a collector in succession. That arrangement can be constructed very compactly, but, insofar as the concept has gained acceptance, it is used for television transmitters having a relatively low transmission power of a maximum of 60 kW in the UHF band, with the result that that solution can be used in competition with standard cavity amplifiers, but cannot yield the high power required for ion beam acceleration.

At frequencies of from 100 MHz to 400 MHz, however, high-power klystrons, which would be perfectly capable of delivering amplification of several megawatts, lose the advantages that they would otherwise have because of the technical outlay and especially because of their overall length at such low frequencies. On the other hand, because of the use of a control grid, klystrodes, as mentioned above, can be used only under extremely limited conditions in terms of the maximum high-frequency output achievable and in terms of the achievable maintenance intervals. Output tubes, such as cavity amplifiers, remain significantly below an output of 1 MW in permanent operation within the frequency range in question, and in pulsed operation the maximum output falls from about 3 MW in the lower frequency range to below 1 MW in the upper frequency range, with the result that these also cannot be used for several megawatts. The overall efficiency in those output tubes also falls as a result of the fact that a cathode heating power of typically 10 kW must be applied continuously at the requisite pulse repetition rates to amplify ion beam pulses of from several Hertz up to 50 Hz.

The problem of the invention is accordingly to provide a high-power high-frequency amplifier in the frequency range of from 100 MHz to approximately 400 MHz that achieves transmission powers of up to 10 MW in pulsed operation with a pulse length of 1 ms and a repetition rate of less than or equal to 50 Hz. A further problem of the invention is to provide a technical solution that overcomes the current critical situation in

the manufacture of high-frequency output tubes, whereby fewer and fewer companies are manufacturing such output tubes, with the result that, in addition to the above-mentioned limitations of that type of amplifier, long-term supply does not seem guaranteed.

The problem is solved by the independent claims, and advantageous developments of the invention are to be found in the dependent claims.

According to the invention, a device for electron beam pulse formation and amplification is provided, that comprises an electron gun, a high-frequency deflector, a d.c. voltage deflector, a collector having an opposing field, a post-deflection accelerator, an output coupler to couple the power of the electron beam to a consumer and a main collector for taking up the residual power of the electron beam. For that purpose, the above-listed devices are arranged behind one another in the direction of the electron beam.

The electron beam gun first produces a continuous electron beam, which is deflected in the high-frequency deflector, excited by a high-frequency exciting signal, so that the electron beam can be forwarded periodically in the ion beam axis only in the region of the zero crossings of that signal. That effect is amplified by the subsequent d.c. voltage deflector and the portion of the electron beam that has been deflected is collected in a collector having an opposing field and that current is back-coupled to the cathode of the electron gun. The electron beam that has been broken down into electron packages in that manner is accelerated in a post-deflection accelerator and fed to an output coupler, which is able to couple the power of the electron beam to a consumer. The remaining non-decoupled residual power of the electron beam is fed to a main collector. Thus, instead of the longitudinal velocity modulation used in the klystron, advantageously the present invention uses transverse high-frequency electrical fields in the high-frequency deflector and transversely-directed static electrical fields in the d.c. voltage deflector, in order to form and pre-amplify electron pulses.

Accordingly, within a high-frequency period about 80% of the continuously delivered electron beam is deflected and collected in a negatively biased collector having opposing voltage. The remaining electron beam pulses continuing on the beam axis in the form of electron packages then pass through the main acceleration of several

A further solution according to the invention consists of a device for ion beam acceleration that comprises an ion accelerator tank having a central container axis for guiding and accelerating a pulsed ion beam of heavy ions in the container axis. That device further comprises an electron beam pulse formation and amplification device

having an electron beam axis for microstructuring and amplifiers of current pulses to supply the device for ion beam acceleration with high-frequency power.

That solution is characterised in that the electron beam pulse formation and amplification device is arranged with its electron beam axis transverse and offset relative to the container axis and comprises, outside the ion accelerator tank, an electron gun, a high-frequency deflector, a d.c. voltage deflector, a collector having an opposing field and a post-deflection accelerator, whereas inside the ion accelerator tank the device comprises an output coupler to provide coupling of the power of the electron beam to a consumer and a main collector for taking up the residual power of the electron beam. The components of the electron beam pulse formation and amplification device listed are arranged behind one another in the direction of the electron beam.

That solution has the advantage that the ion accelerator tank itself is used simultaneously as an output circuit for the power amplification step. A transfer of power from the amplifier to the tank is not required. Coupling of the output stage to the tank volume is thus possible. An assembly for ion beam acceleration for ion beams for heavy ions is thus obtained, which can be manufactured extremely manageably and extremely inexpensively.

To provide coupling between an operative electron beam and an ion accelerator tank, there is used a site, of suitable potential, along the drift tube mounting of the ion beam. A transverse electrical alternating field with suitable time structure deflects electrons in an unfavourable temporal position directly after the pre-acceleration of the electron beam, with the result that only electron pulses having the desired frequency for amplifying the ion beam pulses pass through the main acceleration and are then decelerated in the field of the ion accelerator tank, because their energy is coupled to the ion beam.

Thus, in a preferred embodiment of the invention, the consumer is directly the pulsed ion beam.

In a further preferred embodiment of the invention, the output coupler comprises a resonator having in the ion accelerator tank an upper annular gap surrounding the

electron beam radially and a lower annular gap surrounding the electron beam radially. Passage of the electron beam through two annular gaps, namely an upper and a lower annular gap, in the tank appears to be advantageous since the electron beam has to reach the cooled collector in order to discharge its residual energy in the main collector. For that purpose, advantageously the drift distance between the gaps is kept as short as possible in order to achieve favourable geometry that does not substantially impair the voltage distribution across the foot of the drift tube. In addition, independently of their phase position in the pulse, as the electrons pass through the two annular gaps they advantageously discharge the same energy to the ion beam, with the result that the residual energy in the main collector or collector is less than 10% of the pulse energy.

In order to arrange annular gaps that have been adapted in such a manner in the ion accelerator tank, the output coupler also comprises between the annular gaps a coupling stage, which surrounds the electron beam coaxially and is arranged radially offset and transverse to the ion beam inside the ion accelerator tank, the coupling stage being fastened to a drift tube mounting of the ion beam.

In a further preferred embodiment of the invention, the electron beam gun is a Pierce-type electron beam gun. Such a gun advantageously produces a high-perveance electron beam having correspondingly high space-charge constants according to the Child-Langmuir equation at pulse lengths of 1 ms, which achieves a gun current of, for example, 40 A at an acceleration voltage of 40 kV.

In a further preferred embodiment, the high-frequency deflector comprises a homogeneous transversely directed alternating field, by means of which short electron beam packages are created in the operating frequency range of from 100 to 400 MHz, whereas the electron beam in the interpulse periods is deflected and fed to a collector having an opposing field, which in turn makes the current available to the cathode of the electron beam gun.

In a further preferred embodiment of the invention, the d.c. voltage deflector comprises a non-homogeneous temporally constant transverse electrical field, whereas the electron beam is simultaneously transversely stabilised by means of a longitudinal magnetic field, with the result that the condition of Brillouin equilibrium remains fulfilled.

In a further preferred embodiment, the output coupler comprises in its output circuit a resonator, which communicates with the electron beam by way of an annular gap. Energy can in turn be extracted from the resonator by a consumer, which is coupled thereto by a coaxial lead or a waveguide or is coupled directly thereto, as in the case of the ion beam, with the result that the electron packages in the electron beam are decelerated and have to be collected in the main collector with only very low energy which, in some cases, is below 10% of the total electron beam energy.

In addition to the solution found for direct coupling to an ion beam consumer, the output circuit also comprises a single-column annular cavity as resonator, with the cavity surrounding the ion beam. By means of that solution it is possible to connect any desired consumers to the power-amplifying device according to the invention by way of coaxial cables or waveguides.

The pulse length and the repetition rate of the electron beam, the so-called macrostructure, can be freely selected in the solution according to the invention, with the result that it is possible to achieve pulse lengths of one millisecond at repetition frequencies of below 50 Hz and an output of 10 MW with the device according to the invention and the method according to the invention.

Since a narrow-band HF resonator, as indicated in the preferred embodiments of the invention in the form of an annular cavity having an annular gap, can be excited effectively by an electron beam only when the beam has an intensity modulation at the corresponding operating frequency, that so-called microstructure of the electron beam is produced by means of the method according to the invention. That method according to the invention for electron beam pulse formation and amplification comprises the following method steps:

production of an electron beam by means of an electron beam gun;

action upon the electron beam of a high-frequency alternating field with simultaneous high-frequency deflection of the electron beam;

In a further preferred embodiment of the method, the undeflected electron packages are moved and guided along the beam axis at the temporal spacing of an operating frequency and enter an output circuit of the device, which output circuit is in the form of a resonator, at a main acceleration voltage of from 200 kV to 400 kV. In the process, the

resonator in the output circuit of the device starts to operate, with high-frequency fields in the resonator taking up the energy of the electrons, decelerating them and feeding an output, preferably a coaxial cable and/or a waveguide.

The remaining residual energy of the electrons is preferably deposited in a main collector. In a preferred embodiment of the method, for electrical beam deflection in the high-frequency deflector for an operating frequency f the actuating high-frequency signal is composed of a main component at a frequency of $f/2$ and a superposition of a frequency of $5f/2$ in an amplitude ratio of 5:1. The operating frequency is from 100 to 400 MHz and, per period, about 20% of the electron beam particles are passed on in pulses, since, as a result of the superposition of the two frequencies, a corresponding zero crossing is obtained for a corresponding timespan per period.

The invention will now be explained in greater detail with reference to Figures, in which:

Fig. 1 is a schematic diagram of a first embodiment of a device for electron beam pulse formation and amplification.

Fig. 2 is a diagram of a period of a high-frequency voltage signal applied to a high-frequency deflector.

Fig. 3 shows the deflection action on electrons in a high-frequency deflector.

Figures 4a and 4b are schematic diagrams of possible electrical fields in a d.c. voltage deflector.

Fig. 5 is a cross-section through an asymmetrical d.c. voltage deflector having the equipotential lines drawn in.

Fig. 6 shows a plurality of intensity profiles along the electron beam axis for various diaphragm openings of the collector having an opposing field.

Fig. 7 is a diagram of the distribution density of the electrons after passing through the high-frequency deflector.

Fig. 8 is a diagram of the distribution density of the electrons after passing through the high-frequency deflector and the d.c. voltage deflector.

Fig. 9 is a schematic diagram of a device for electron beam pulse formation and amplification.

Fig. 10 is a schematic diagram of a device for ion beam acceleration.

Fig. 1 is a schematic diagram of a first embodiment of a device for electron beam pulse formation and amplification. The device consists substantially of a vacuum-tight housing 28, in which there are housed, connected in series, an electron gun 6, a high-frequency deflector 7, a d.c. voltage deflector 8, a collector having an opposing field 9 and a post-deflection accelerator (not shown), which is indicated in Fig. 9 by the reference number 10. The schematic diagram in Fig. 1 serves essentially to illustrate the principle by which the transverse deflection unit for microstructuring the electron beam functions. The corresponding multiparticle calculations for the formation of electron packages in that device were carried out using suitable software packages.

The section shown in Fig. 1 from the electron gun 6 to the collector having an opposing field 9, which collects the deflected electrons that are shown in the beam cross-section shown in the x/z plane by hatching, comprises the main parts of the electron beam formation device according to the invention. There can clearly be seen the two deflection systems 7 and 8 arranged directly behind one another, it being possible for the second electrostatic deflection unit 8 to be supplied by the cathode potential U_c . The electrical field direction E_y , which is arranged perpendicular to the plane of representation, must be oriented, for $x > 0$, in the opposite direction than for $x < 0$ in order to amplify further the electron deflection of the high-frequency deflection unit connected in series before it. The surrounding area of the z axis, as shown in the diagram, is kept virtually field-free in the d.c. voltage deflector 8 by overlapping of the earthed electrodes, in order to disrupt the electron packages that are passing through as little as possible.

Fig. 2 is a diagram of a period of a high-frequency voltage signal applied to the high-frequency deflector 7. Time is plotted in nanosecond units on the abscissa and the high-

frequency deflection voltage is plotted in kV on the ordinate. Within a high-frequency period at an operating frequency f , corresponding excitation frequencies of the high-frequency deflector 7 produce a recurring plateau 51 at voltage 0 V. That recurring plateau 51 at voltage 0 V defines the proportion of beam passing through that is not deflected. The diagram of Fig. 2 also indicates the steeply graded voltage slopes 53 and 54 at the start and end of the plateau 51, as a result of which strong deflection of the electron beam is triggered, which, in turn, defines the interpulse periods. The plateau itself corresponds approximately to a proportion of the beam of 20% or to a phase width of 70° in units of the operating frequency. Accordingly the actuating HF signal consists of a main component at frequency $f/2$ and a superposed frequency $5f/2$. At an amplitude ratio of about 5:1 and the corresponding phase relation, the desired signal form shown in Fig. 2 is produced, which is composed of components $V = \sin(\pi ft) - 0.2 V \times \sin(5\pi ft)$.

Fig. 3 shows the deflection action on the electrons in a high-frequency deflector 7. The electrons describe the paths shown there in the x/y plane under the influence of the electrical and magnetic fields. The advantage of crossed electrical and magnetic fields is that the deflection by means of $E \times B$ drift occurs substantially in the x/y plane such that the deflector plates of the high-frequency deflector 7 constitute no delimitation, provided the gyroradius r_g is suitably selected.

Figures 4a and 4b are schematic diagrams of possible electrical fields in a d.c. voltage deflector 8. In the embodiment under discussion here, the asymmetrical d.c. voltage deflector of Fig. 4b is used in a slightly modified form, as shown in Fig. 5. Compared with the symmetrical d.c. voltage deflector of Fig. 4a, the asymmetrical d.c. voltage deflector 8 has the advantage of being simpler to construct as a result of having only four deflection plates 36 to 38 compared with six deflection plates 30 to 35 in Fig. 4a.

Fig. 5 is a cross-section through an asymmetrical d.c. voltage deflector 8 having the equipotential lines 29 drawn in. It can be seen clearly in this diagram that the centre between the deflection plates 40 to 43 is kept field-free so that electrons that fly through those deflection plates in the centre are not additionally deflected or are deflected additionally only to a small degree. Moreover, the modification of the embodiment according to Fig. 5, compared with the schematic diagram according to Fig. 4b, lies in the fact that the earthed (0 V) deflection plates 41 and 42 are initially parallel to the

Fig. 8 is a diagram of the distribution of electron density after passage through the high-frequency deflector 7 and the d.c. voltage deflector 8. Again, the x position is plotted in mm on the abscissa and the electron density is plotted in any desired comparable units on the ordinate. After the d.c. voltage deflector, the maxima of the deflected electrons concentrate at a distinct spacing from the centre of the beam, which lies at 0.0 mm. Only 20% of the electrons remain in the centre of the beam and can be further accelerated in the subsequent high-accelerator. That 20% is formed of electron

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packages or electron pulses as shown spatially in Fig. 6. The cross-section of the particle packages to be transported further in its density distribution is about 13 mm in the x direction and about 11 mm in the y direction. The diaphragm opening of the collector having an opposing field cuts a corresponding electron pulse beam from that cross-section.

Fig. 9 is a schematic diagram of a device for electron beam pulse formation and amplification. In Fig. 9, identical reference numbers identify identical components of the device as in Fig. 1. For that reason, an explanation of those device components will largely be omitted. In Fig. 9, in addition to the device components shown in Fig. 1, there can be seen a frequency converter f_1 which oscillates at half the operating frequency f and is fed, via a phase shifter 45, to an amplifier 48 which amplifies the signal of the frequency converter f_1 to about 50 kW. Superposed on that signal is a signal that is delivered by a second frequency converter f_2 , which produces a frequency of $5f/2$ and superposes that signal upon the signal of the first frequency converter at the coupling point 50. In the process, in addition to the correct phase, amplitude adaptation is carried out by the amplifier 49, so that the amplitude of the signal of the frequency converter f_2 is only $1/5$ of the amplitude of the frequency converter f_1 . That signal, which takes the shape of the diagram shown in Fig. 2 for a period of time, is applied to the plates of the high-frequency deflector 7. Superposed on the signal is a magnetic field, which is produced by the coil 47 inside the housing 28.

An electron beam 14 is produced between the plates in the electron beam axis 5 by an electron beam gun 6, which, in that embodiment, is a Pierce-type electron beam gun. That electron gun produces a high-perveance electron beam having high space-charge constants according to the Child-Langmuir equation and is stabilised transversely by means of a longitudinal magnetic field of the coil 47 and held in Brillouin equilibrium.

After the electron beam has been divided up in the high-frequency deflector 7, both the deflected electron packages and the electron packages remaining in the centre of the axis are guided through the d.c. voltage deflector 8. In the process, the temporal spacing of the packages is determined by the operating frequency f , which is from 100 to 400 MHz. Whilst the portion of the electron beam package that is deflected is taken up by the collector 9 having an opposing field and is fed by way of a connecting lead to the

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cathode of the electron beam gun 6, the approximately 20% of the electrons of the electron beam that are in the centre reach the post-deflection accelerator 10, which amplifies the energy of the electron beam pulses or electron packages at an acceleration voltage, in this embodiment, of 300 kV, enabling them to interact with the connecting annular resonator 15 by way of the annular gap 25.

The resonator, which is excited by the frequency of the electron beam, extracts energy from the electron packages, which energy is fed, in this embodiment, to a coaxial output 12 by way of an antenna 23. That coaxial cable can be connected to a consumer. In other embodiments of the invention, the consumer is directly an ion beam of an acceleration chamber or of an ion accelerator tank, for example of an ion beam therapy system or an ion beam system for investigating materials, which is operated substantially with heavy ions, such as carbon and oxygen ions.

The output 12 may also be a waveguide, which communicates with the resonator 15 by way of a coupling window or is connected to the resonator 15 by way of a coaxial duct. The energy not extracted from the resonator 15 and thus from the electron beam 14 through the output is taken up by the main collector 13. That main collector 13 preferably has water-cooled walls in order to draw off the residual energy which, in this embodiment, is below 10 %. At a maximum output of 10 MW, however, a high cooling capacity is required in order to prevent the housing of the main collector from melting.

Fig. 10 is a schematic diagram of a device for ion beam acceleration. The principle according to the invention has the advantage that it can be introduced directly into a system for ion beam acceleration. Accordingly, Fig. 10 shows a device 51 for ion beam acceleration that comprises an ion accelerator tank 1 having a central container axis 2 for guiding and accelerating a pulsed ion beam 3 in the container axis 2. For that purpose, an electron beam pulse formation and amplification device 4 having an electron beam axis 5 for microstructuring and amplifying current pulses to supply the device 51 for ion beam acceleration with high-frequency power is arranged in such a manner that the electron beam pulse formation and amplification device 4 is arranged with its electron beam axis 5 transverse and offset relative to the container axis 2, and comprises, outside the ion accelerator tank 1, an electron beam gun 6, a high-frequency deflector 7, a d.c. voltage deflector 8, a collector 9 having an opposing field and a post-

deflection accelerator 10 and comprises, inside the ion accelerator tank 1, an output coupler 11 for coupling the power of the electron beam 14 to a consumer 12, which, in this case, is the pulsed ion beam 3, with a main collector 13 taking up the residual power of the electron beam 14 and the mentioned components of the device being arranged behind one another in the direction of the ion beam 14.

In order to decouple the energy of the electron beam 14 from the electron beam pulse formation and amplification device 4, there are arranged an upper annular gap 16 and a lower annular gap 17 having arranged between them a coupling stage that surrounds the ion beam coaxially. The coupling stage 18 is held by the drift tube mounting 19, which simultaneously surrounds the ion beam 3 in the region of the centre of the ion accelerator tank 1. The size of the gap and the spacing of the gap and the displacement spacing between the electron beam axis and the ion beam axis are matched to one another in such a manner that the volume of the ion accelerator tank 1 can serve as a resonator for the pulsed electron beam, the resonator acting directly upon the pulsed ion beam guided in the centre.

Half the operating frequency f of the ion beam 3 is fed to a coupling point 50 in the frequency converter f_1 by way of a phase shifter 45 and an amplifier 48, at which coupling point 50 there is simultaneously applied, by the frequency converter f_2 , by way of the amplifier 49, the $f/2$ operating frequency f . Those superposed frequencies are used to operate the high-frequency deflector 7, which modulates the ion beam from the electron beam gun 6.

Then, in a d.c. voltage deflector 8 the deflection and separation between deflected ion beam portions and thus the interpulse intervals, and ion beam portions that are guided further in the centre and thus pulse lengths, are amplified, with the result that the deflected ion beam portions can be taken up by the collector 9 having an opposing field. The electron packages guided further centrally on the ion beam axis 5 are brought to a correspondingly high energy in the post-deflection accelerator 10 so that they can enter into resonance with the volume space of the ion accelerator tank 1. In the process, a substantial portion of the electron beam energy is transferred to the ion beam pulses, whilst a small residual amount of less than 10% of the electron beam energy is fed to the main collector 13. In contrast to Fig. 9, this solution according to the invention

comprises an upper annular gap 16 and a lower annular gap 17, which surround the electron beam, whilst a coupling piece 18 is arranged between them.

List of reference numbers

1	ion accelerator tank
2	central container
3	pulsed ion beam
4	electron beam pulse formation and amplification device
5	electron beam axis
6	electron gun
7	high-frequency deflector
8	d.c. voltage deflector
9	collector having an opposing field
10	post-deflection accelerator
11	output coupler
12	consumer
13	main collector
14	electron beam
15	resonator
16	upper annular gap
17	lower annular gap
18	coupling stage
19	non-homogeneous field
20	homogeneous transversely directed alternating field
21	output circuit
22	annular cavity
23	antenna
24	coaxial cable
25	annular gap
26	single-column cavity
27	annular resonator chamber
28	housing
29	equipotential lines
30-35	deflection plates of the symmetrical d.c. voltage deflector
36-39	deflection plates of the asymmetrical d.c. voltage deflector
40-43	deflection plates of the d.c. voltage deflector

44	centre line
45	phase shifter
47	coil
48	amplifier
49	amplifier
f_1	frequency converter
f_2	frequency converter
50	coupling point
51	device for ion beam acceleration
52	plateau
53-54	slopes